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SOT-227 Silicon Carbide Schottky Barrier Diode, 650 V, 120 A



PRIMARY CHARACTERISTICS							
V_{R}	650 V						
V _F (typical) at 60 A, per diode	1.39 V						
Q _C (typical), per diode	164 nC						
I _{F(DC)} per module at T _C = 127 °C	120 A						
Type	Modules - diode, SiC Schottky						
Package	SOT-227						
Circuit configuration	Two separate diodes, parallel pin-out						

FEATURES

Virtually no recovery tail and no switching losses



 Majority carrier diode using Schottky technology on SiC wide band gap material RoHS COMPLIANT

- Improved V_F and efficiency by thin wafer technology
- High speed switching, low switching losses
- Positive temperature coefficient, for easy paralleling
- · Electrically isolated base plate
- Large creepage distance between terminal
- · Simplified mechanical designs, rapid assembly
- Designed and qualified for industrial level
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Wide band gap SiC based 650 V Schottky diode, designed for high performance and ruggedness.

Optimum choice for high speed hard switching and efficient operation over a wide temperature range, it is also recommended for all applications suffering from Silicon ultrafast recovery behavior.

Typical applications include AC/DC PFC and DC/DC ultra high frequency output rectification in FBPS and LLC converters

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Cathode to anode voltage	V _R		650	V		
Continuous forward current per diode	I _F	T _C = 127 °C	60	۸		
Single pulse forward current per diode	I _{FSM}	T _J = 25 °C, 6 ms square pulse	340	А		
Maximum power dissipation per diode	P _D	T _C = 127 °C	114	W		
RMS isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V		
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +175	°C		

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	I _R = 300 μA	650	-	-	
Forward voltage	V _{FM}	I _F = 60 A	-	1.39	1.59	V
		I _F = 60 A, T _J = 150 °C	-	1.61	-	
		V _R = 650 V	-	2.6	120	
Reverse leakage current	I _{RM}	T _J = 125 °C, V _R = 650 V	-	9.2	-	μΑ
		T _J = 150 °C, V _R = 650 V	-	13.1	-	
Junction capacitance	C_{T}	V _R = 650 V, f = 1 MHz	-	240	-	pF



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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total capacitive charge	Q _C	V _R = 400 V	-	164	=	nC

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance junction to case, per diode	Б		-	-	0.42	
Thermal resistance junction to case, per module	R_{thJC}		-	-	0.21	°C/W
Thermal resistance case to heatsink, per module	R _{thCS}	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Manustina taunus		Torque per diode	-	-	1.1 (9.7)	Nm (lbf.in)
Mounting torque		Torque to heatsink	-	-	1.8 (15.9)	Nm (lbf.in)
Case style				SOT	-227	

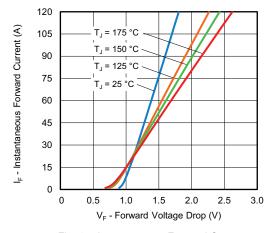


Fig. 1 - Instantaneous Forward Current vs. Forward Voltage Drop Characteristics

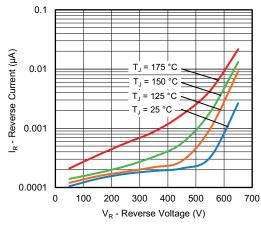


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

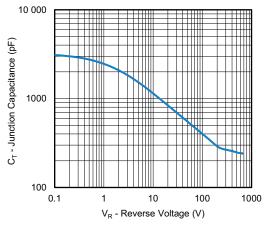


Fig. 3 - Junction Capacitance vs. Reverse Voltage

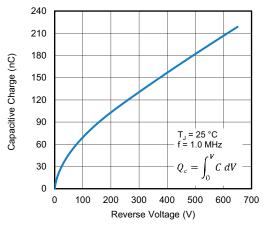
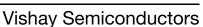


Fig. 4 - Typical Capacitive Charge vs. Reverse Voltage





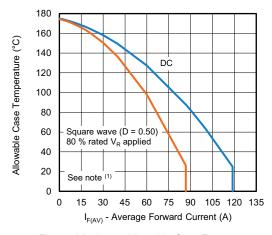


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

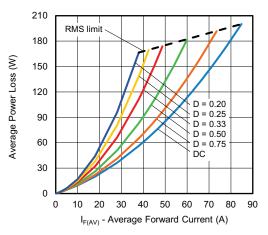


Fig. 6 - Forward Power Loss Characteristics

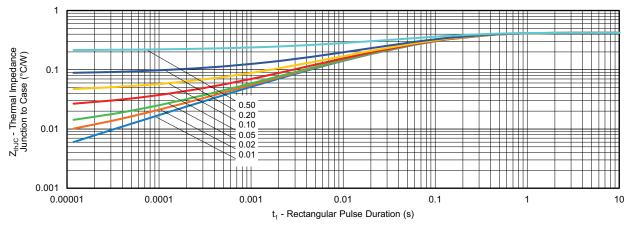
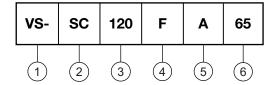


Fig. 7 - Maximum Thermal Impedance Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - SC = SiC Schottky Barrier Diode

- Current rating per module (120 = 120 A)

- F = circuit configuration (two separate diodes, parallel pin-out)

Package indicator (SOT-227 standard insulated base)

6 - Voltage rating (65 = 650 V)



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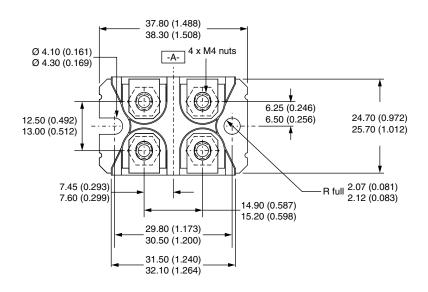
CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Two separate diodes, parallel pin-out	F	Lead Assignment 4 0 0 3 4 1 0 0 2 1			

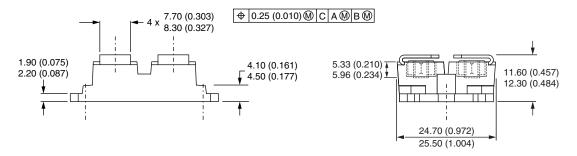
LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95423					
Packaging information	www.vishay.com/doc?95425				

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SOT-227 Generation 2

DIMENSIONS in millimeters (inches)





Note

· Controlling dimension: millimeter



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